

Data sheet

SAW filter
GPS + COMPASS + GLONASS

Series/type: B8839

Ordering code: B39162B8839P810

Date: November 15, 2018

Version: 2.3

DCN: 80-PA243-27 Rev. C

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RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

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RF360 Europe GmbH A Qualcomm – TDK Joint Venture

1 Application

- Simultaneous usage of GPS, COMPASS and GLONASS bands
- Usable passbands: 2.0 MHz for GPS, 4.092 MHz for COMPASS and 8.34 MHz for GLONASS
- High out of band selectivity
- Unbalanced to unbalanced operation
- \blacksquare No matching network required for operation at 50 Ω

2 Features

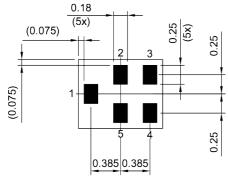
- RoHS compatible
- Package size 1.1 mm × 0.9 mm
- Package height 0.45 mm (max.)
- Approximate weight 1 mg
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)



Figure 1: Picture of component with example of product marking.

3 Package

BOTTOM VIEW



Pad and pitch tolerance ±0.05

4 Pin configuration

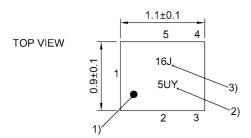
■ 1 Input

■ 4 Output

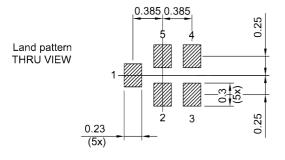
■ 2, 3, 5 Ground

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 18).

5 Matching circuit

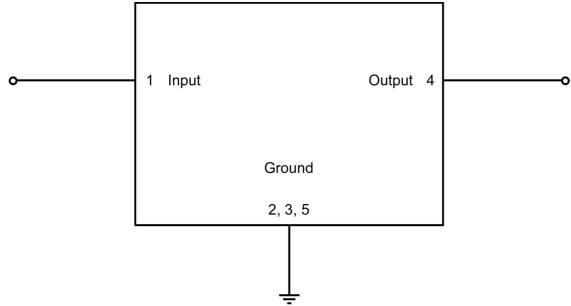


Figure 3: Schematic of matching circuit. No external matching components required.



6 Characteristics

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

 $\begin{array}{lll} \mbox{Input terminating impedance} & Z_{_{\rm IN}} & = 50 \ \Omega \\ \mbox{Output terminating impedance} & Z_{_{\rm OUT}} & = 50 \ \Omega \\ \end{array}$

Characteristics			$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency		$f_{_{ m C}}$	_	1582.47	_	MHz
Insertion loss		α				
	1559.052 1563.144 MHz		_	1.7	2.6	dB
	1574.42 1576.42 MHz		_	1.2	2.0	dB
	1597.55 1605.89 MHz		_	1.9	2.6	dB
Group delay		τ				
	1597.55 1605.89 MHz		_	5.0	15	ns
VSWR		VSWR				
@ input port	1559.052 1563.144 MHz		_	1.6	2.1	
	1574.42 1576.42 MHz		_	1.4	1.9	
	1597.55 1605.89 MHz		_	1.6	2.1	
@ output port	1559.052 1563.144 MHz		_	1.4	2.1	
	1574.42 1576.42 MHz		_	1.3	1.9	
	1597.55 1605.89 MHz		_	1.7	2.1	
Attenuation		α				
	10 925 MHz		50	56	_	dB
	777 798 MHz		50	57	_	dB
	814 915 MHz		50	58	_	dB
	925 960 MHz		52	58	_	dB
	1427 1463 MHz		45	51	_	dB
	1710 1785 MHz		43	49	_	dB
	1850 1980 MHz		40	45	_	dB
	2010 2025 MHz		40	47	_	dB
	2305 2315 MHz		50	55	_	dB
	2401 2483 MHz		46	53	_	dB
	2500 2570 MHz		46	51	_	dB
	5150 5850 MHz		25	30	_	dB



7 **Maximum ratings**

Storage temperature	T _{STG} ²⁾ = -40 °C +85 °C ¹⁾	
DC voltage	$ V_{DC} = 5.0 \text{ V (max.)}^{3)}$	
ESD voltage	$V_{ESD}^{4} = 50 \text{ V (max.)}$	Machine model.
	V _{ESD} ⁵⁾ = 300 V	Human body model.
	V _{ESD} ⁶⁾ = 700 V	Charged device model.
Input power @ input port: 1710 1755 MHz	P _{IN} = 15 dBm (min.)	Continuous wave for 2000 h @ 55 °C.

¹⁾ Extended upperlimit: 168h@125°C acc. to IEC 60068-2-2 Bb.

²⁾ Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

¹⁶⁸h Damp Heat Steady State acc. IEC 60068-2-67 Cy.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

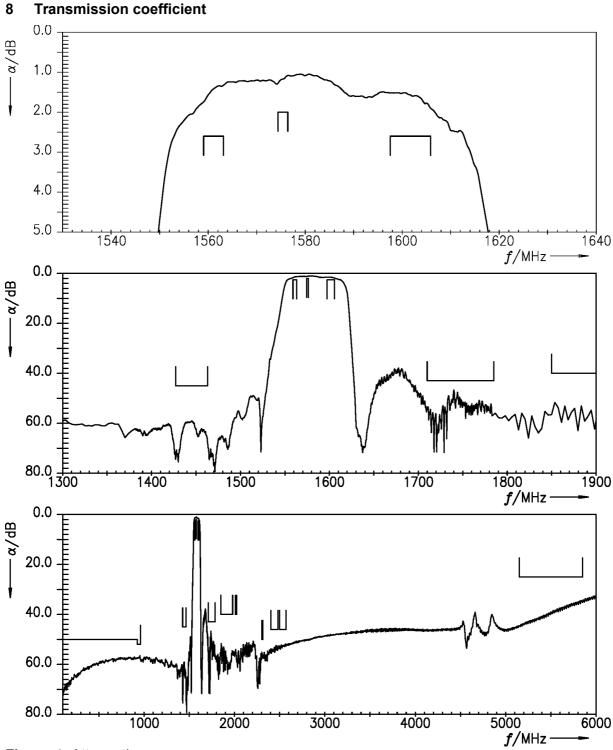
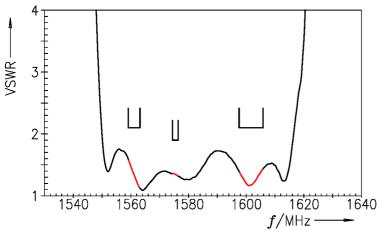


Figure 4: Attenuation.

9 Reflection coefficients



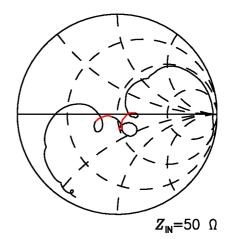
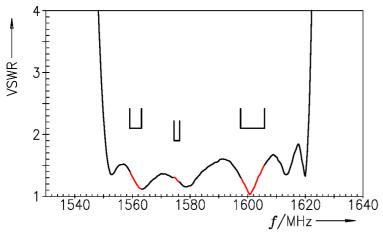


Figure 5: Reflection coefficient at input port.



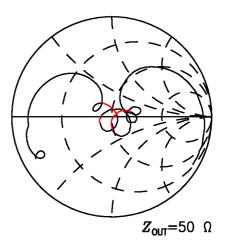


Figure 6: Reflection coefficient at output port.

10 Packing material

10.1 Tape

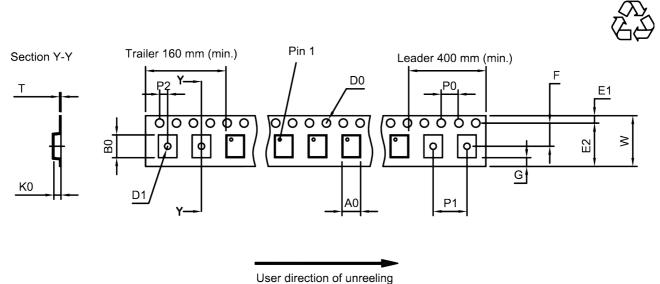


Figure 7: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A ₀	1.02±0.05 mm	E ₂	6.25 mm (min.)	P ₁	2.0±0.1 mm
B ₀	1.22 _{±0.05} mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D ₀	1.55±0.05 mm	G	_	T	0.25±0.03 mm
D_1	0.55±0.1 mm	K_0	0.6±0.05 mm	W	8.0+0.3/-0.1 mm
E ₁	1.75 _{±0.1} mm	P_0	4.0 _{±0.1} mm		

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

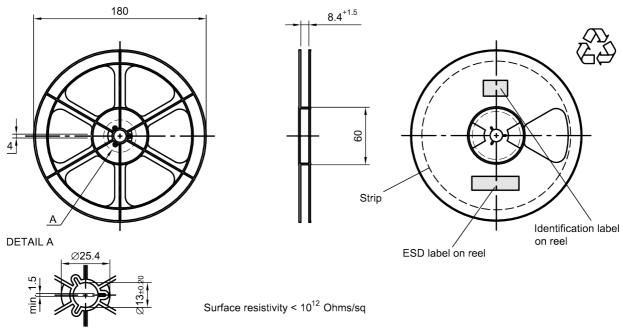


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.

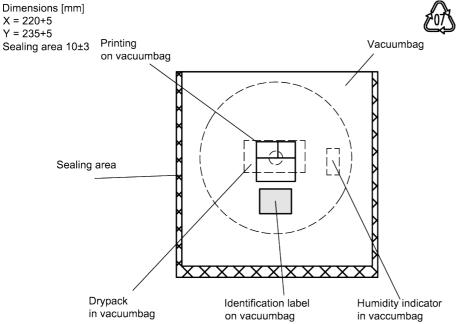


Figure 9: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

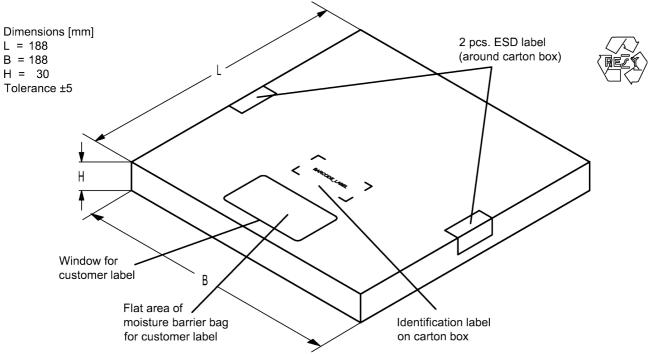


Figure 10: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

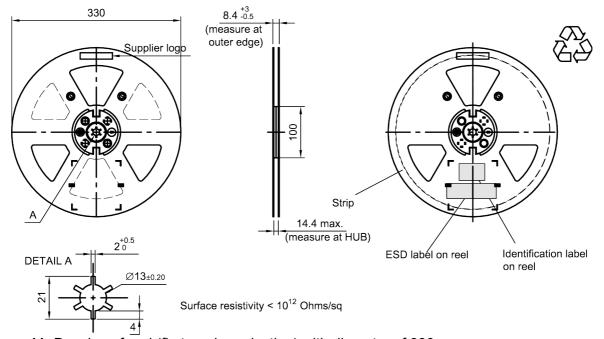


Figure 11: Drawing of reel (first-angle projection) with diameter of 330 mm.

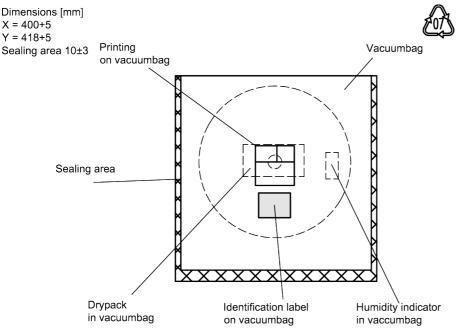


Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

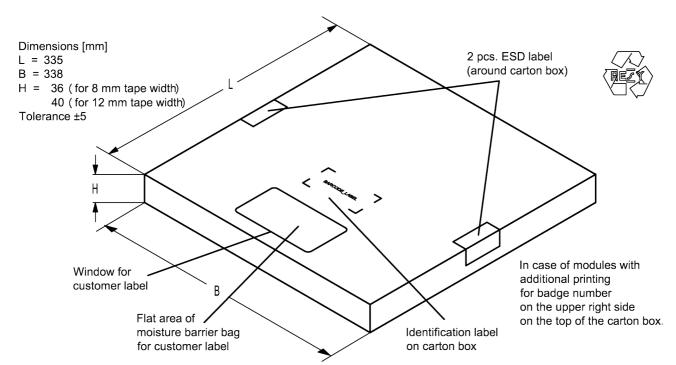


Figure 13: Drawing of folding box for reel with diameter of 330 mm.



11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B8839 is 8M7.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$ 12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	Α	26	Т
11	В	27	V
12	С	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

	Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47	
value	code	value	code	
0	0	24	R	
1	1	25	S	
2	2	26	Т	
3	3	27	U	
4	4	28	V	
5	5	29	W	
6	6	30	X	
7	7	31	Y	
8	8	32	Z	
9	9	33	b	
10	Α	34	d	
11	В	35	f	
12	С	36	h	
13	D	37	n	
14	E	38	r	
15	F	39	t	
16	G	40	V	
17	Н	41	\	
18	J	42	?	
19	K 43		{	
20	L	44	}	
21	M	45	<	
22	N	46	>	
23	Р			

Table 2: Lists for encoding and decoding of marking.



12 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T _{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads
	·

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

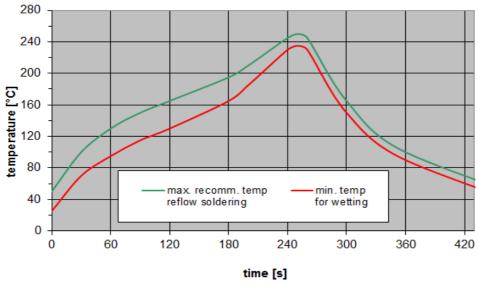


Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.



13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Ordering codes and packing units

Ordering code	Packing unit
B39162B8839P810	15,000 pcs
B39162B8839P810S 5	5,000 pcs

Table 4: Ordering codes and packing units.



14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

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